STPS5H100

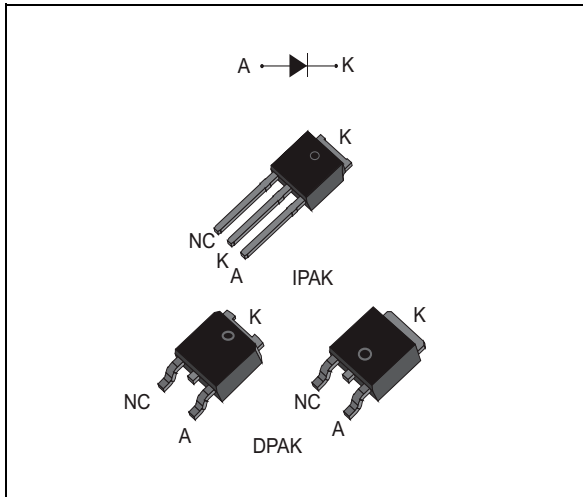## High voltage power Schottky rectifier

Description

This high voltage Schottky barrier rectifier is packaged in DPAK and IPAK and designed for high frequency compact switched mode power supply such as adaptators and on board DC-DC converters.

Table 1. Device summary

Symbol	Value
$I_{F(AV)}$	5 A
V_{RRM}	100 V
T_j	175 °C
$V_F(max)$	0.61 V

Features

- Negligible switching losses
- High junction temperature capability
- Low leakage current
- Good trade off between leakage current and forward voltage drop
- Avalanche capability specified
- ECOPACK®2 compliant component for IPAK and DPAK on demand

1   Characteristics

Table 2. Absolute ratings (limiting values)

Symbol	Parameter		Value	Unit
V_{RRM}	Repetitive peak reverse voltage		100	V
$I_{F(RMS)}$	RMS forward voltage		10	A
$I_{F(AV)}$	Average forward current, δ = 0.5	T_C = 165 °C	5	A
I_{FSM}	Surge non repetitive forward current	t_p = 10 ms sinusoidal	75	A
P_{ARM}	Repetitive peak avalanche power	t_p = 10 µs, T_j = 125 °C	515	W
T_{stg}	Storage temperature range		-65 to + 175	°C
T_j	Maximum operating junction temperature[1]		175	°C

1. $\frac{dP tot}{dTj} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
$R_{th(j-c)}$	Junction to case	2.5	°C/W

Table 4. Static electrical characteristics

Symbol	Parameter	Tests conditions		Min.	Typ	Max.	Unit
I_R [1]	Reverse leakage current	T_j = 25 °C	V_R = V_{RRM}			3.5	µA
		T_j = 125 °C			1.3	4.5	mA
V_F [2]	Forward voltage drop	T_j = 25 °C	I_F = 5 A			0.73	V
		T_j = 125 °C			0.57	0.61	
		T_j = 25 °C	I_F = 10 A			0.85	
		T_j = 125 °C			0.66	0.71	

1. t_p = 5 ms, δ < 2%

2. t_p = 380 µs, δ < 2%

To evaluate the conduction losses use the following equation:

$P = 0.51 \times I_{F(AV)} + 0.02\ I_{F^2(RMS)}$

Figure 1. Average forward power dissipation versus average forward current
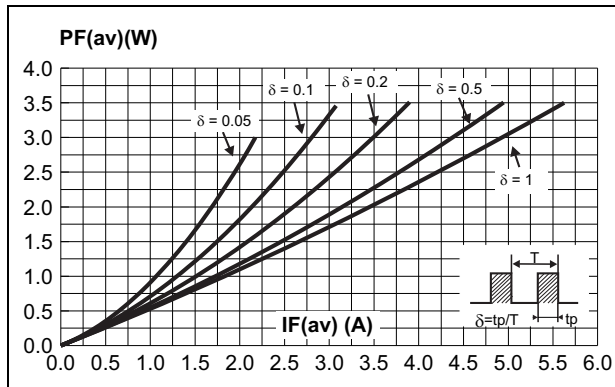

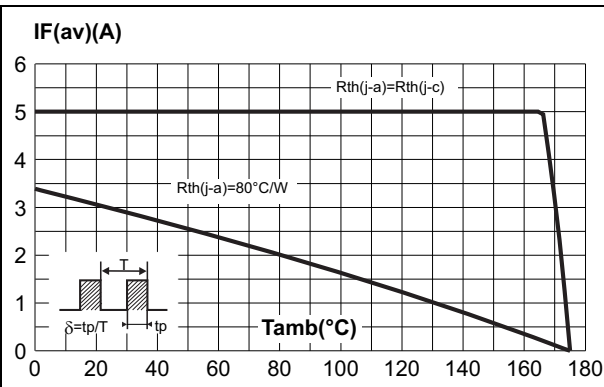**Figure 2. Average forward current versus ambient temperature, δ = 0.5**

Figure 3. Normalized avalanche power derating versus pulse duration at T_j = 125 °C
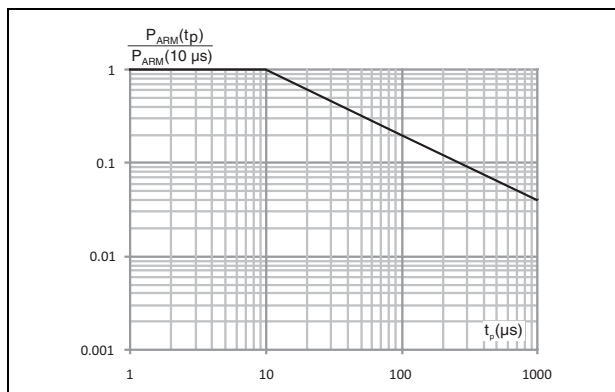

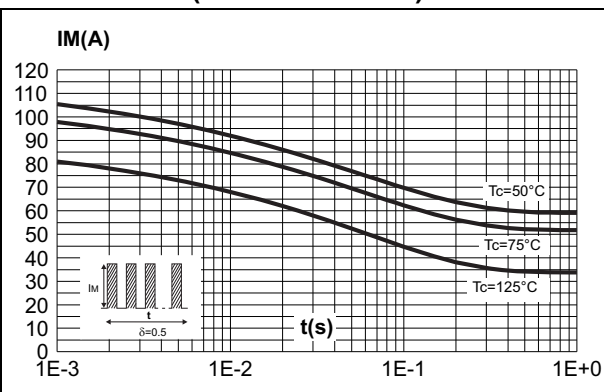**Figure 4. Non repetitive surge peak forward current versus overload duration (maximum values)**

Figure 5. Relative variation of thermal impedance junction to case versus pulse duration
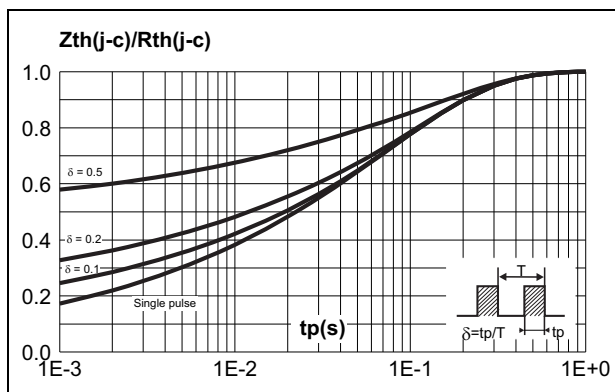

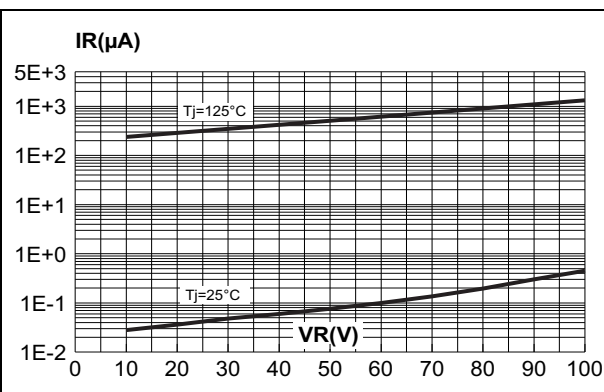**Figure 6. Reverse leakage current versus reverse voltage applied (typical values)**

Figure 7. Junction capacitance versus reverse voltage applied (typical values)
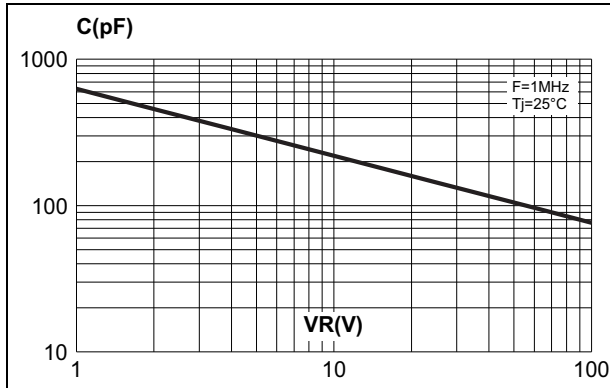

Figure 8. Forward voltage drop versus forward current (maximum values)
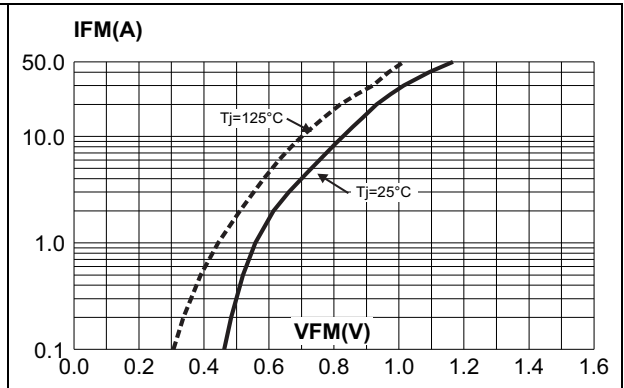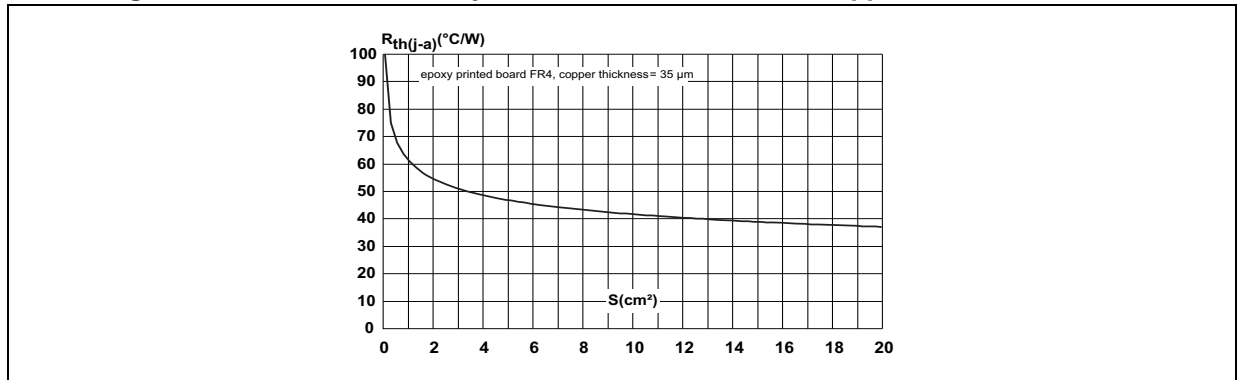

Figure 9. Thermal resistance junction to ambient versus copper surface under tab
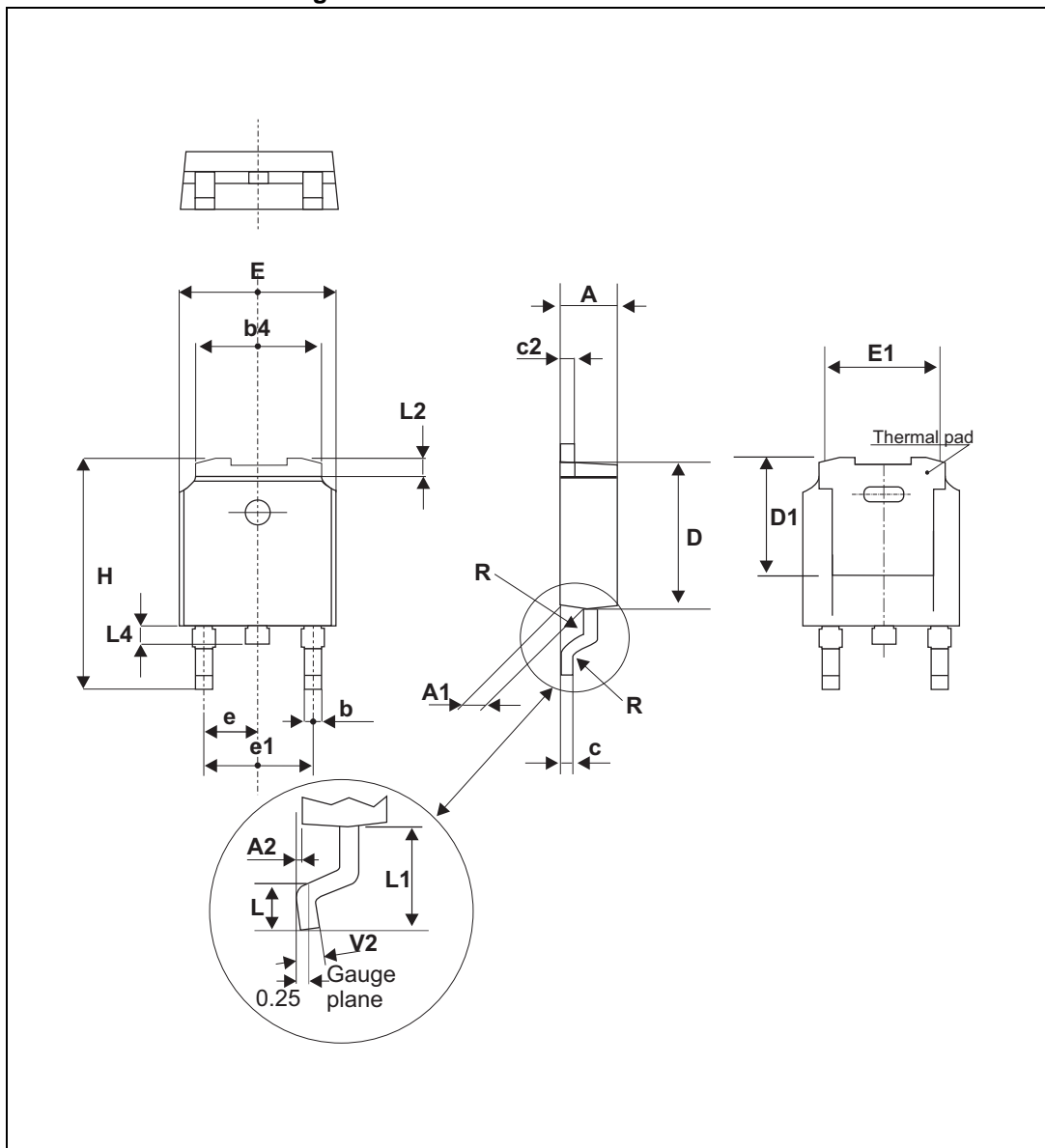
2   Package Information

- Epoxy meets UL94,V0
- Cooling method: by conduction (C)

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK® is an ST trademark.

Figure 10. DPAK dimension definitions

Note: *This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.*

Table 5. DPAK dimension values

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	2.18		2.40	0.085		0.094
A1	0.90		1.1	0.035		0.043
A2	0.03		0.23	0.001		0.01
b	0.64		0.90	0.025		0.035
b4	4.95		5.46	0.195		0.215
c	0.46		0.61	0.018		0.024
c2	0.46		0.60	0.018		0.024
D	5.97		6.22	0.235		0.245
D1	5.10			0.201		
E	6.35		6.73	0.250		0.265
E1	4.32			0.170		
e1	4.4		4.7	0.173		0.185
H	9.35		10.40	0.368		0.407
L	1.0		1.78	0.039		0.070
L2			1.27			0.05
L4	0.6		1.02	0.024		0.040
V2	0°		8°	0°		8°

Figure 11. DPAK footprint dimensions (in mm)

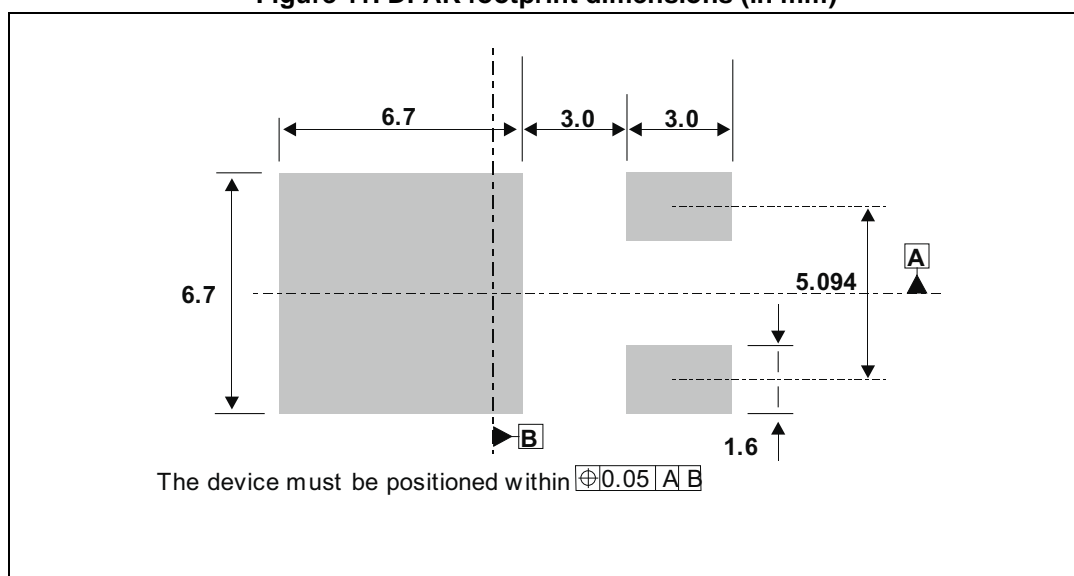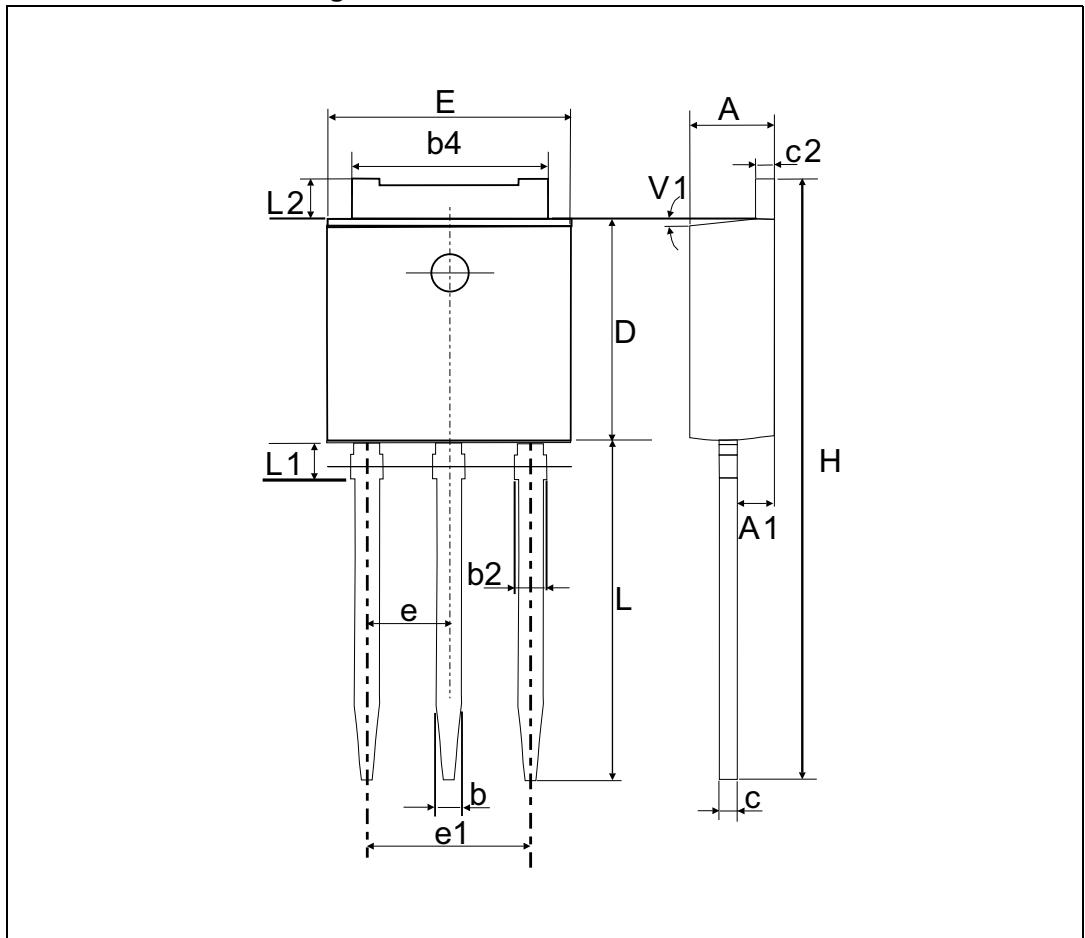The device must be positioned within ⊕ 0.05 A B

Figure 12. IPAK dimension definitions

Note: *This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.*

Table 6. IPAK dimension values

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	**Typ.**	**Max.**	**Min.**	**Typ.**	**Max.**
A	2.20		2.40	0.086		0.094
A1	0.90		1.10	0.035		0.043
A3	0.70		1.30	0.027		0.051
B	0.64		0.90	0.025		0.035
B2	5.20		5.40	0.204		0.212
B3			0.95			0.037
B5		0.30			0.035	
C	0.45		0.60	0.017		0.023
C2	0.48		0.60	0.019		0.023
D	6		6.20	0.236		0.244
E	6.40		6.65	0.252		0.262
e		2.28			0.090	
G	4.40		4.60	0.173		0.181
H		16.10			0.634	
L	9		9.40	0.354		0.370
L1	0.8		1.20	0.031		0.047
L2		0.80	1		0.031	0.039
V1		10°			10°	

3   Ordering Information

Table 7. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS5H100B	S5H100	DPAK	0.30 g	75	Tube
STPS5H100B-TR	S5H100			2500	Tape and reel
STPS5H100H	S5H100H	IPAK	0.40 g	75	Tube

4   Revision history

Table 8. Document revision history

Date	Revision	Description of Changes
Jul-2003	6B	Last issue.
03-Nov-2005	7	DPAK footprint dimensions updated.
15-Feb-2006	8	ECOPACK statement added.
05-Mar-2007	9	IPAK package added.
01-Aug-2014	10	Updated DPAK package information.
17-Sep-2014	11	Updated *Table 2*, title *Figure 3* and *Figure 11*.
14-Oct-2014	12	Updated DPAK package information.

IMPORTANT NOTICE – PLEASE READ CAREFULLY